



#### 20V P-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>C</sub> = +25°C
-20V	$5.5m\Omega @V_{GS} = -4.5V$	-71A
-20 V	$7.5 \text{m}\Omega @V_{GS} = -2.5 \text{V}$	-60A

### **Description**

This MOSFET is designed to minimize on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for highefficiency power management applications.

### **Applications**

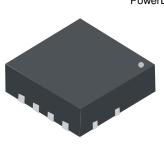
- Load switches
- Power management functions

#### **Features**

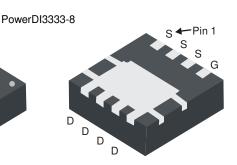
- Low RDS(ON) Ensures On-State Losses are Minimized
- Small Form Factor, Thermally Efficient Package Enables Higher **Density End Products**
- Occupies Just 33% of the Board Area Occupied by SO-8 Enabling Smaller End Product
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

### **Mechanical Data**

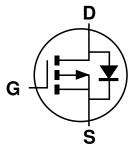
- Package: PowerDI®3333-8
- Package Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish—Matte Tin Annealed over Copper Lead-Frame; Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.030 grams (Approximate)







**Bottom View** 



**Equivalent Circuit** 

### **Ordering Information** (Note 4)

Part Number	Dookogo	Packing			
Part Number	Package	Qty.	Carrier		
DMP26M1UFG-7	PowerDI3333-8	2,000	Tape & Reel		
DMP26M1UFG-13	PowerDI3333-8	3,000	Tape & Reel		

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/



# **Marking Information**

PowerDI3333-8

XXX BF2

BF2 = Product Type Marking Code YWX = Date Code Marking

Y = Year (ex: 2 = 2022) W = Week (ex: a = week 27; z represents week 52 and 53)

X = Internal Code (ex: U = Monday)

Date Code Key

Year	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	1	2	3	4	5	6	7	8	9	0	1	2

Week	1-26	27-52	53
Code	A-Z	a-z	Z

Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Code	Т	U	V	W	X	Υ	Z

# **Maximum Ratings** (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V <sub>DSS</sub>	-20	V
Gate-Source Voltage		V <sub>GSS</sub>	±10	V
Continuous Drain Current (Note 7) Vgs = -4.5V	ID	-71 -56	А	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	IDM	-110	Α	
Maximum Continuous Body Diode Forward Current	Is	-2	Α	
Avalanche Current L = 0.1mH (Note 8)	las	-37	Α	
Avalanche Energy L = 0.1mH (Note 8)		Eas	-71	mJ

# Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	1.67	W
Thermal Resistance, Junction to Ambient (Note 5)	Reja	75	°C/W
Total Power Dissipation (Note 6)	PD	3.0	W
Thermal Resistance, Junction to Ambient (Note 6)	Reja	41	°C/W
Thermal Resistance, Junction to Case (Note 7)	Rejc	3.0	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
Thermal resistance from junction to soldering point (on the exposed drain pad). Notes:

8.  $I_{AS}$  and  $E_{AS}$  ratings are based on low frequency and duty cycles to keep  $T_J = +25$ °C.



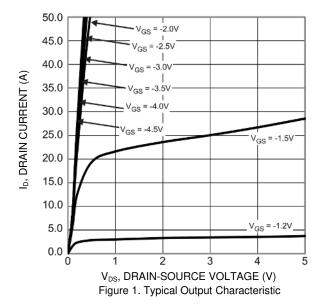
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 9)						
Drain-Source Breakdown Voltage	BVDSS	-20	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$
Zero Gate Voltage Drain Current	IDSS	_	_	-1	μΑ	V <sub>DS</sub> = -16V, V <sub>GS</sub> = 0V
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 8V$ , $V_{DS} = 0V$
ON CHARACTERISTICS (Note 9)						
Gate Threshold Voltage	$V_{GS(TH)}$	-0.4	_	-1.0	V	$V_{DS}=V_{GS},\ I_D=-250\mu A$
		_	4.7	5.5		$V_{GS} = -4.5V, I_D = -15A$
Static Drain-Source On-Resistance	_	_	5.8	7.5	mΩ	V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -10A
Static Drain-Source On-Nesistance	RDS(ON)	_	7.8	12	11112	V <sub>GS</sub> = -1.8V, I <sub>D</sub> = -1A
		_	11	17		V <sub>GS</sub> = -1.5V, I <sub>D</sub> = -1A
Diode Forward Voltage	V <sub>SD</sub>	_	-0.7	-1.1	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = -10A
DYNAMIC CHARACTERISTICS (Note 10)			•	•		
Input Capacitance	Ciss	_	5392	_		
Output Capacitance	Coss	_	608	_	pF	$V_{DS} = -10V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	564	_		1 – 1.01/11/2
Gate Resistance	Rg	_	2.05	_	Ω	V <sub>DS</sub> = 0V, V <sub>GS</sub> = 0V, f = 1.0MHz
Total Gate Charge (VGS = -4.5V)	Qg	_	75	_		
Total Gate Charge (V <sub>GS</sub> = -10V)	Qg	_	164	_	0	V 40V 1 00A
Gate-Source Charge	Qgs	_	6.9	_	nC	$V_{DD} = -10V, I_D = -20A$
Gate-Drain Charge	Qgd	_	19.8	_		
Turn-On Delay Time	t <sub>D(on)</sub>	_	9	_		
Turn-On Rise Time	t <sub>R</sub>	_	24	_	Ī	V <sub>DD</sub> = -10V, V <sub>GEN</sub> = -4.5V,
Turn-Off Delay Time	t <sub>D(off)</sub>	_	69	_	ns	$R_{GEN} = 1\Omega$ , $I_D = -10A$
Turn-Off Fall Time	tr	_	107	_	1	
Reverse Recovery Time	t <sub>RR</sub>	_	54	_	ns	100 11/11 1000/
Reverse Recovery Charge	Q <sub>RR</sub>	_	55	_	nC	-I <sub>F</sub> = -10A, di/dt = 100A/μs

Notes:

<sup>9.</sup> Short duration pulse test used to minimize self-heating effect. 10. Guaranteed by design. Not subject to product testing.





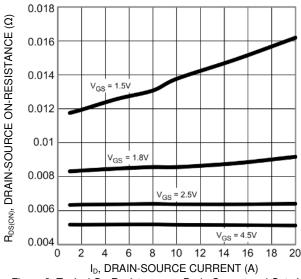


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

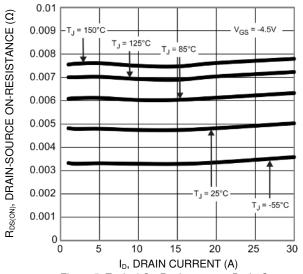


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

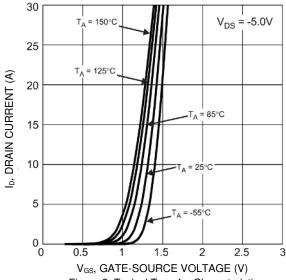


Figure 2. Typical Transfer Characteristic

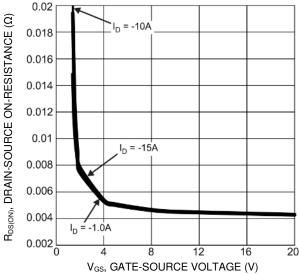


Figure 4. Typical Transfer Characteristic

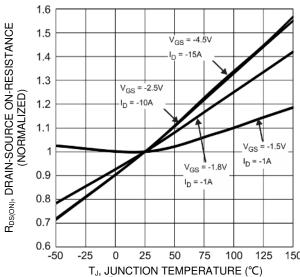


Figure 6. On-Resistance Variation with Junction Temperature



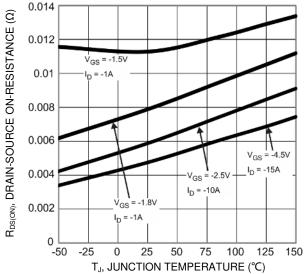
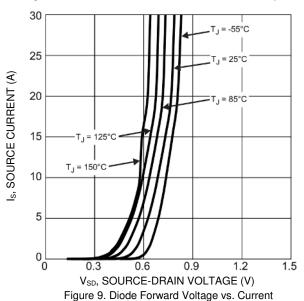


Figure 7. On-Resistance Variation with Junction Temperature



10 (N) 8 8 V<sub>DS</sub> = -10V V<sub>DS</sub> = -10V V<sub>DS</sub> = -20A V<sub>DS</sub> = -20A V<sub>DS</sub> = -20A V<sub>DS</sub> = -10V V<sub>DS</sub> =

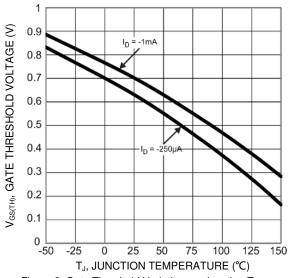
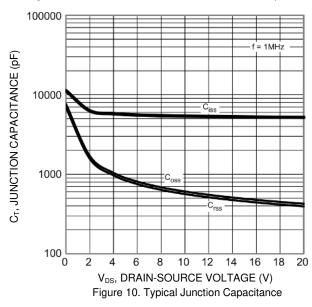


Figure 8. Gate Threshold Variation vs. Junction Temperature



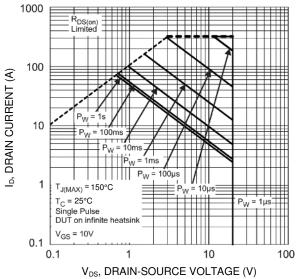


Figure 12. SOA, Safe Operation Area



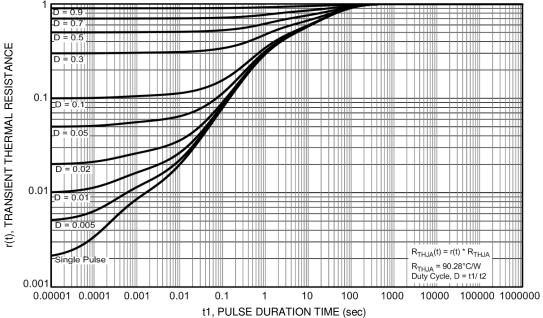


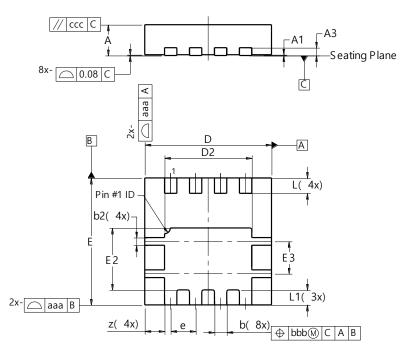
Figure 13. Transient Thermal Resistance



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI3333-8

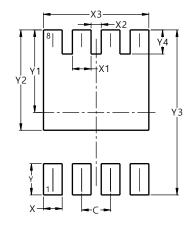


	PowerDI3333-8							
Dim	Min	Max	Тур					
Α	0.75	0.85	0.80					
<b>A</b> 1	0.00	0.05	0.02					
A3	-	-	0.203					
b	0.27	0.37	0.32					
b2	_	_	0.20					
D	3.25	3.35	3.30					
D2	2.22	2.32	2.27					
Е	3.25	3.30						
E2	1.56	1.66	1.61					
E3	0.79	0.89	0.84					
е	-	-	0.65					
L	0.35	0.45	0.40					
1	_	ı	0.39					
Z	0.515							
aaa	0.25							
bbb	0.10							
CCC	0.10							
All I	Dimens	sions ir	n mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI3333-8



Dimensions	Value (in mm)
С	0.650
X	0.420
X1	0.420
X2	0.230
Х3	2.370
Υ	0.700
Y1	1.850
Y2	2.250
Y3	3.700
Y4	0.540



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